

Z8691 Z8®ROMLESS MICROCONTROLLER

FEATURES

- Complete microcomputer, 24 I/O lines, and up to 64K bytes of addressable external space each for program and data memory.
- 143-byte register file, including 124 general-purpose registers, 3 I/O port registers, and 16 status and control registers.
- Vectored, priority interrupts for I/O, counter/timers, and UART.
- On-chip oscillator that accepts crystal or external clock drive.
- Full-duplex UART and two programmable 8-bit counter/timers, each with a 6-bit programmable prescaler.
- Register Pointer so that short, fast instructions can access any one of the nine working-register groups.
- Single +5V power supply—all I/O pins TTL compatible.
- 8 MHz/12 MHz versions.

GENERAL DESCRIPTION

The Z8691 is a ROMless version of the Z8 single-chip microcomputer. The Z8691 offers all the outstanding features of the Z8 family architecture except an on-chip program ROM. Use of external memory rather than a

preprogrammed ROM enables this Z8 microcomputer to be used in low volume applications or where code flexibility is required.

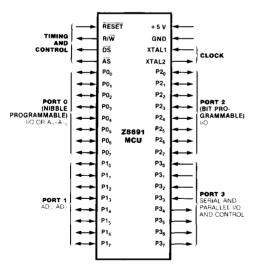


Figure 1. Pin Functions

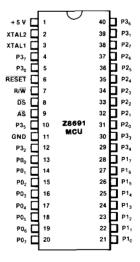


Figure 2a. 40-pin Dual-In-Line Package (DIP), Pin Assignments

The Z8691 can provide up to 16 output address lines, thus permitting an address space of up to 64K bytes of data or program memory. Eight address outputs (AD $_0$ -AD $_7$) are provided by a multiplexed, 8-bit, Address/Data bus. The remaining 8 bits can be provided by the software configuration of Port 0 to output address bits A $_8$ -A $_{15}$.

Available address space can be doubled (up to 128K bytes) by programming bit 4 of Port 3 (P3 $_4$) to act as a data memory select output (\overline{DM}). The two states of \overline{DM} together with the 16 address outputs can define separate data and memory address spaces of up to 64K bytes each.

There are 143 bytes of RAM located on-chip and organized as a register file of 124 general-purpose registers, 16 control and status registers, and three I/O port registers. This register file can be divided into nine groups of 16 working registers each. Configuring the register file in this manner allows the use of short format instructions; in addition, any of the individual registers can be accessed directly.

The pin functions and the pin assignments of the Z8691 40-pin and 44-pin packages are illustrated in Figures 1 and 2, respectively.

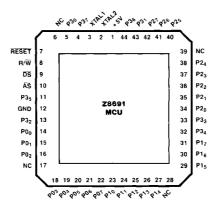


Figure 2b. 44-pin Chip Carrier, Pin Assignments

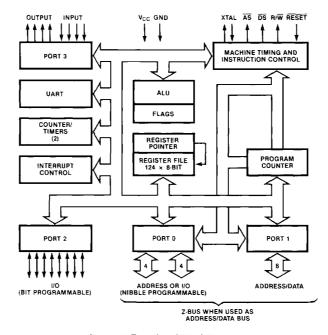


Figure 3. Functional Block Diagram

ARCHITECTURE

Z8691 architecture is characterized by a flexible I/O scheme, an efficient register and address space structure and a number of ancillary features that are helpful in many applications.

Microcomputer applications demand powerful I/O capabilities. The Z8691 fulfills this with 24 pins available for input and output. These lines are grouped into three ports of eight lines each and are configurable under software control to provide timing, status signals, serial or parallel I/O with or without handshake, and an Address bus for interfacing external memory.

Three basic address spaces are available: program memory,

data memory and the register file (internal). The 143-byte random-access register file is composed of 124 general-purpose registers, three I/O port registers, and 16 control and status registers.

To unburden the program from coping with real-time problems such as serial data communication and counting/timing, an asynchronous receiver/transmitter (UART) and two counter/timers with a large number of user-selectable modes are offered on-chip. Hardware support for the UART is minimized because one of the on-chip timers supplies the bit rate. Figure 3 shows the Z8691 block diagram.

PIN DESCRIPTION

AS. Address Strobe (output, active Low). Address Strobe is pulsed once at the beginning of each machine cycle. Addresses output via Port 1 for all external program or data memory transfers are valid at the trailing edge of AS.

DS. Data Strobe (output, active Low). Data Strobe is activated once for each external memory transfer.

P0₀·P0₇, P2₀·P2₇, P3₀·P3₇. I/O Port Lines (input/outputs, TTL-compatible). These 24 lines are divided into three 8-bit I/O ports that can be configured under program control for I/O or external memory interface (Figure 3).

P10-P17. Address/Data Port (bidirectional). Multiplexed

address (A_0-A_7) and data (D_0-D_7) lines used to interface with program and data memory.

RESET. Reset (input, active Low). RESET initializes the Z8691. After RESET the Z8691 is in the extended memory mode. When RESET is deactivated, program execution begins from program location 000C_H.

 R/\overline{W} . Read/Write (output). R/\overline{W} is Low when the Z8691 is writing to external program or data memory.

XTAL1, XTAL2. Crystal 1, Crystal 2 (time-base input and output). These pins connect a parallel-resonant crystal to the on-chip clock oscillator and buffer.

ADDRESS SPACES

Program Memory. The Z8691 addresses 64K/62K bytes of external program memory space (Figure 4).

The first 12 bytes of program memory are reserved for the interrupt vectors. These locations contain six 16-bit vectors that correspond to the six available interrupts. Program execution begins at location 000C_H after a reset.

Data Memory. The Z8691 can address 64K bytes of external data memory. External data memory may be included with or separated from the external program memory space. DM, an optional I/O function that can be programmed to appear on pin P3₄, is used to distinguish between data and program memory space.

Register File. The 143-byte register file includes three I/O port registers (R0, R2, R3), 124 general-purpose registers (R4-R127) and 16 control and status registers (R240-R255). These registers are assigned the address locations shown in Figure 5.

Z8691 instructions can access registers directly or indirectly with an 8-bit address field. This also allows short 4-bit register addressing using the Register Pointer (one of the control registers). In the 4-bit mode, the register file is divided into nine working-register groups, each occupying 16 contiguous locations (Figure 5). The Register Pointer addresses the starting location of the active working-register group (Figure 6).

Stacks. Either the internal register file or the external data memory can be used for the stack. A 16-bit Stack Pointer (R254 and R255) is used for the external stack, which can reside anywhere in data memory. An 8-bit Stack Pointer (R255) is used for the internal stack that resides within the 124 general-purpose registers (R4-R127).

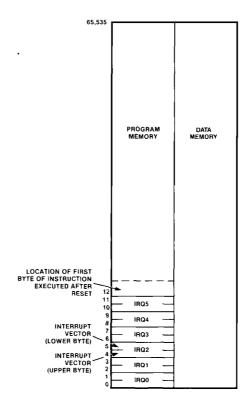


Figure 4. Program Memory Map

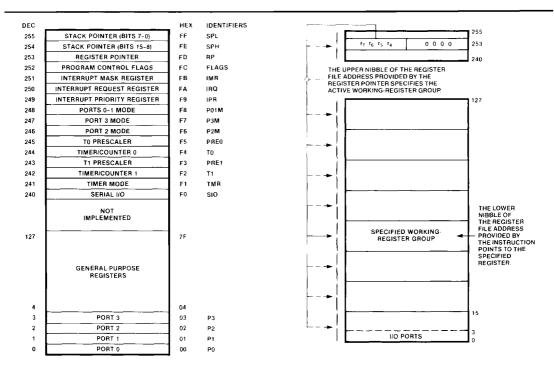


Figure 5. The Register File

Figure 6. The Register Pointer

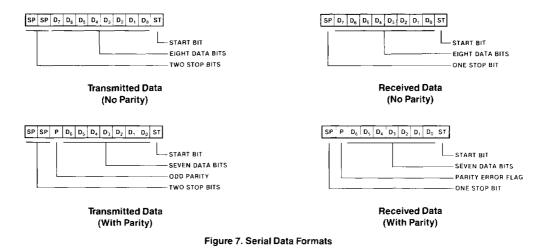
SERIAL INPUT/OUTPUT

Port 3 lines P3₀ and P3₇ can be programmed as serial I/O lines for full-duplex serial asynchronous receiver/transmitter operation. The bit rate is controlled by Counter/Timer 0, with a maximum rate of 62.5K bits/second at 8 MHz or 93.75K bits/second at 12 MHz on the Z8691.

The Z8691 automatically adds a start bit and two stop bits to transmitted data (Figure 7). Odd parity is also available as an option. Eight data bits are always transmitted, regardless of

parity selection. If parity is enabled, the eighth data bit is used as the odd parity bit. An interrupt request (IRQ4) is generated on all transmitted characters.

Received data must have a start bit, eight data bits, and at least one stop bit. If parity is on, bit 7 of the received data is replaced by a parity error flag. Received characters generate the IRQ3 interrupt request.



965

COUNTER/TIMERS

The Z8691 contains two 8-bit programmable counter/timers (T_0 and T_1), each driven by its own 6-bit programmable prescaler. The T_1 prescaler can be driven by internal or external clock sources; however, the T_0 prescaler is driven by the internal clock only.

The 6-bit prescalers can divide the input frequency of the clock source by any number from 1 to 64. Each prescaler drives its counter, which decrements the value (1 to 256) that has been loaded into the counter. When the counter reaches the end of count, a timer interrupt request — IRQ4 (T_0) or IRQ5 (T_1) — is generated.

The counters can be started, stopped, restarted to continue, or restarted from the initial value. The counters can also be programmed to stop upon reaching zero (single-pass mode)

or to automatically reload the initial value and continue counting (modulo-n continuous mode). The counters, but not the prescalers, can be read any time without disturbing their value or count mode.

The clock source for T_1 is user-definable; it can be either the internal microprocessor clock divided by four, or an external signal input via Port 3. The Timer Mode register configures the external timer input as an external clock, a trigger input that can be retriggerable or nonretriggerable, or as a gate input for the internal clock. The counter/timers can be programmably cascaded by connecting the T_0 output to the input of T_1 . Port 3 line $P3_6$ also serves as a timer output (T_{OUT}) through which T_0 , T_1 or the internal clock can be output.

I/O PORTS

The Z8691 has 24 lines available for input and output. These lines are grouped into three ports of eight lines each and are configurable as input, output or address. Under software control, the ports can be programmed to provide address

outputs, timing, status signals, serial I/O, and parallel I/O with or without handshake. All ports have active pull-ups and pull-downs compatible with TTL loads.

Port 1 is a dedicated Z-BUS compatible memory interface. The operations of Port 1 are supported by the Address Strobe (\overline{AS}) and Data Strobe (\overline{DS}) lines, and by the Read/Write (R/\overline{W}) and Data Memory (\overline{DM}) control lines. The low-order program and data memory addresses (A_0-A_7) are output through Port 1 (Figure 8) and are multiplexed with data in/out (D_0-D_7) . Instruction fetch and data memory read/write operations are done through this port.

Port 1 cannot be used as a register nor can a handshake mode be used with this port.

The Z8691 wakes up with the 8 bits of Port 1 configured as address outputs for external memory. If more than eight address lines are required, additional lines can be obtained by programming Port 0 bits as address bits. The

least-significant four bits of Port 0 can be configured to supply address bits A_8 - A_{11} for 4K byte addressing or both nibbles of Port 0 can be configured to supply address bits A_8 - A_{15} for 64K byte addressing.

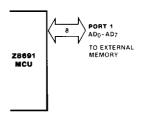


Figure 8. Port 1

Port 0 can be programmed as a nibble I/O port, or as an address port for interfacing external memory (Figure 9). When used as an I/O port, Port 0 can be placed under handshake control. In this configuration, Port 3 lines $P3_2$ and $P3_5$ are used as the handshake controls DAV₀ and RDY₀. Handshake signal assignment is dictated by the I/O direction of the upper nibble $P0_4$ - $P0_7$.

For external memory references, Port 0 can provide address bits A_8 - A_{11} (lower nibble) or A_8 - A_{15} (lower and upper nibbles) depending on the required address space. If the address range requires 12 bits or less, the upper nibble of Port 0 can be programmed independently as I/O while the lower nibble is used for addressing.

Port 0 lines are configured as address lines A_8 - A_{15} after a reset. If one or both nibbles are needed for I/O operation, they must be configured by writing to the Port 0 Mode register.

To permit the use of slow memory, an automatic wait mode of two oscillator clock cycles is configured for the bus timing of the Z8691 after each reset. The initialization routine could include reconfiguration to eliminate this extended timing mode.

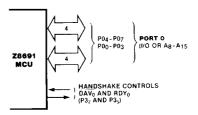


Figure 9. Port 0

Port 2 bits can be programmed independently as input or output (Figure 10). This port is always available for I/O operations. In addition, Port 2 can be configured to provide open-drain outputs.

Port 2 may also be placed under handshake control. In this configuration, Port 3 lines P31 and P36 are used as the handshake controls lines DAV2 and RDY2. The handshake signal assignment for Port 3 lines P31 and P36 is dictated by the direction (input or output) assigned to bit 7 of Port 2.

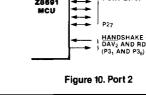


Figure 10. Port 2

P20

PORT 2(1/0)

HANDSHAKE CONTROLS DAV₂ AND RDY₂

Port 3 lines can be configured as I/O or control lines (Figure 11). In either case, the direction of the eight lines is fixed as four input (P3₀-P3₃) and four output (P3₄-P3₇). For serial I/O, lines P30 and P37 are programmed as serial in and serial out, respectively.

Port 3 can also provide the following control functions: handshake for Ports 0 and 2 (DAV and RDY); four external interrupt request signals (IRQ0-IRQ3); timer input and output signals (T_{IN} and T_{OUT}) and Data Memory Select (\overline{DM}).

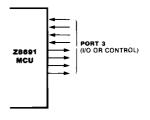


Figure 11. Port 3

INTERRUPTS

The Z8691 allows six different interrupts from eight sources: the four Port 3 lines P3₀-P3₃, Serial In, Serial Out, and the two counter/timers. These interrupts are both maskable and prioritized. The Interrupt Mask register globally or individually enables or disables the six interrupt requests. When more than one interrupt is pending, priorities are resolved by a programmable priority encoder that is controlled by the Interrupt Priority register.

All interrupts are vectored through locations in program memory. When an interrupt request is granted, an interrupt machine cycle is entered. This disables all subsequent interrupts, saves the Program Counter and status flags, and accesses the program memory vector location reserved for that interrupt. This memory location and the next byte contain the 16-bit address of the interrupt service routine for that particular interrupt request. The Z8691 takes 63 crystal cycles to enter an interrupt subroutine.

Polled interrupt systems are also supported. To accommodate a polled structure, any or all of the interrupt inputs can be masked and the Interrupt Request register polled to determine which of the interrupt requests needs service.

CLOCK

The on-chip oscillator has a high-gain, parallel-resonant amplifier for connection to a crystal or to any suitable external clock source (XTAL1 = Input, XTAL2 = Output).

The crystal source is connected across XTAL1 and XTAL2, using the recommended capacitance ($C_L = 15$ pf maximum) from each pin to ground. The specifications for the crystal are as follows:

- AT cut, parallel-resonant
- Fundamental type
- Series resistance, R_s ≤ 100 Q
- 8 or 12 MHz maximum

INSTRUCTION SET NOTATION

Addressing Modes. The following notation is used to describe the addressing modes and instruction operations as shown in the instruction summary.

IRR Indirect register pair or indirect working-register pair address

In Indirect working-register pair only

X Indexed address DA Direct address RA Relative address IM **Immediate**

R Register or working-register address Working-register address only

IR Indirect-register or indirect working-register

address

lr Indirect working-register address only RR Register pair or working register pair address

Symbols. The following symbols are used in describing the instruction set.

dst Destination location or contents SIC Source location or contents CC Condition code (see list) @ Indirect address prefix

SP Stack pointer (control registers 254-255)

PC Program counter FLAGS Flag register (control register 252) RP Register pointer (control register 253)

IMR Interrupt mask register (control register 251) Assignment of a value is indicated by the symbol "←". For example.

indicates that the source data is added to the destination data and the result is stored in the destination location. The notation "addr(n)" is used to refer to bit "n" of a given location. For example,

dst (7)

refers to bit 7 of the destination operand.

Flags. Control Register R252 contains the following six flags:

С Carry flag Z Zero flag S Sign flag ٧ Overflow flag D Decimal-adjust flag н Half-carry flag

Affected flags are indicated by:

0 Cleared to zero 1 Set to one

Set or cleared according to operation

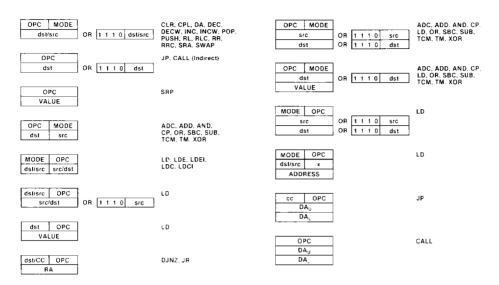
Unaffected Х Undefined

CONDITION CODES

Value	Mnemonic	Meaning	Flags Set
1000		Always true	
0111	С	Carry	C = 1
1111	NC	No carry	C = 0
0110	Z	Zero	Z = 1
1110	NZ	Not zero	Z = 0
1101	PL	Plus	S = 0
0101	MI	Minus	S = 1
0100	OV	Overflow	V = 1
1100	NOV	No overflow	V = 0
0110	EQ	Equal	Z = 1
1110	NE	Not equal	Z = 0
1001	GE	Greater than or equal	$(S XOR V) \approx 0$
0001	LT	Less than	$(S XOR V) \approx 1$
1010	GT	Greater than	$[Z OR (S XOR V)] \approx 0$
0010	LE	Less than or equal	$[Z OR (S XOR V)] \approx 1$
1111	UGE	Unsigned greater than or equal	C = 0
0111	ULT	Unsigned less than	C = 1
1011	UGT	Unsigned greater than	(C = 0 AND Z = 0) = 1
0011	ULE	Unsigned less than or equal	(C OR Z) = 1
0000		Never true	<u>-</u>

INSTRUCTION FORMATS OPC CCF, DI, EI, IRET. NOP. RCF, RET, SCF INC r

One-Byte Instruction



Two-Byte Instruction

Three-Byte Instruction

Figure 12. Instruction Formats

INSTRUCTION SUMMARY

	Addr Mode		F	Flags Affected			ecte	ed		Addr	Mode	Opcode	Flags A		js .	Aff	ect	ed
Instruction and Operation	dst src	Byte (Hex)	С	z	s	٧	D	Н	Instruction and Operation	dst	src	Byte (Hex)	С	z	S	V	D	Н
ADC dst.src ast ← ast + src + C	(Note 1)	1	*	*	*	*	0	*	DEC dst dst ← dst 1	R IR		00 01		*	*	*		
ADD dst.src ast ← ast + src	(Note 1)	0	*	*	*	*	О	*	DECW dst ds! ← ds! - 1	RR IR		80 81		*	*	*	-	
AND dst.src ast ← ast AND src	(Note 1)	5		*	*	C			DI IMR (7) ← 0			8F					_	-
CALL dst SP ← SP - 2 @SP ← PC PC ← dst	DA IRR	D6 D4							DJNZ r.dst r ← r → 1 rf r ≠ 0	RA		rA r = 0 · F	-	_				
CCF C ← N:OT C		EF	*					-	PC ← PC + dst Range + 127, - 128									
CLR dst dst ← 0	R IR	B0 B1							EI IMR (7) ← 1			9F						-
COM dst dst +- NOT dst	R IR	60 61		*	*	0			INC dst dst ← dst + 1	r		rE r = 0 - F		*	*	*		
CP dst.src dst - src	(Note 1)	Α	*	*	*	*				R IR 		20						
DA dst dst ← DA dst	R IR	40 41	*	*	*	X			INCW dst dst ← dst + 1	RR IR		AC A1		*	*	*	24	

INSTRUCTION SUMMARY (Continued)

Instruction	Addr	Mode	Opcode Byte	F	lag	s A	ffe	cte	d
and Operation	dst	src	(Hex)	С	z	S	٧	D	۲
I RET FLAGS ← @SP: SP ← PC ← @SP: SP ← SP			BF ← 1	*	*	*	*	*	*
JP cc.dst if cc is true PC ← dst	DA IRR		cD c = 0 - F 30				_	_	-
JR cc.dst if cc is true. PC ← PC + dst Range: + 127, - 128	RA		cB c = 0 - F						
LD dst.src dst ← src	r r R	im R r	rC r8 r9 r = 0 - F C7			_			
	r X r Ir R	X r ir r R	D7 E3 F3 E4 E5						
	R IR IR	IR IM IM R	E6 E7 F5						
LDC dst,src dst ← src	r rr	irr r	C2 D2						
LDCI dst.src dst ← src r ← r + 1; rr ← rr + 1	lr Irr	rr r	C3 D3						
LDE dst.src dst ← src	r Irr	Irr r	82 92	-					
LDEI dst.src dst ← src r ← r + 1; rr ← rr +	lr Irr 1	lrr Ir	83 93						
NOP			FF						
OR dst.src dst ← dst OR src	(No	ote 1)	4		*	*	0		
POP dst dst ← @SP: SP ← SP + 1	R iR		50 51						
PUSH src SP ← SP - 1: @SP	← src	R IR	70 71						
RCF			CF	0					
RET PC ← @SP: SP ← SI	P + 2		AF			-			
RL dst	R IR		90 91	*	*	*	*		

	Addr Mode	Opcode	Flags Affected									
Instruction and Operation	dst src	Byte (Hex)	С	z	s	٧	D	Н				
RLC dst	J ^R IR	10 11	*	*	*	*						
RR dst	F IR	E0 E1	*	*	*	*						
RRC ast] R IR	C0 C1	*	*	*	*	-	_				
SBC dst,src dst ← dst ← src ← C	(Note 1)	31"	*	*	*	*	1	*				
SCF C ← 1	-	DF	1	_			-	-				
SRA dst [7]	R IR	D0 D1	*	*	*	0						
SRP src RP ← src	lm	31	- *		-	-						
SUB dst.src dst ← dst ← src	(Note 1)	21	*	*	*	*	1	*				
SWAP dst 7 4 3	∍ R ∍ IR	F0 F1	Χ	*	*	Χ	-	-				
TCM dst.src (NOT dst) AND src	(Note 1)	61		*	*	0	_	_				
TM dst.src dst AND src	(Note 1)	7(1)	_	*	*	0		_				
XOR dst.src dst ← ast XOR src	(Note 1)	В		*	*	0						

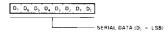
NOTE. These instructions have an identical set of addressing modes, which are encoded for brevity. The first opcode hibble is found in the instruction set table above. The second hibble is expressed symbolically by a . I in this table, and its value is found in the following table to the left of the applicable addressing mode pair. For example, the opcode of an ADC instruction using the addressing modes rides thation) and Ir (source) is 13.

Addr	Mode	Lower
dst	src	Opcode Nibble
r	ſ	2
r	tr	3
R	R	4
R	IR	5
R	M	6
IR	IM	7

REGISTERS

R240 SIO Serial I/O Register

(F0...: Read/Write)



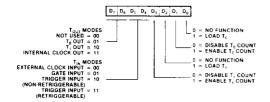
R244 TO Counter/Timer 0 Register

(F4H: Read/Write)



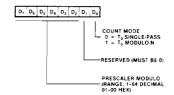
R241 TMR Time Mode Register

(F1_H: Read/Write)



R245 PRE0 Prescaler 0 Register

(F5H: Write Only)



R242 T1 Counter Timer 1 Register

(F2H: Read/Write)



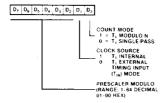
R246 P2M Port 2 Mode Register

(F6H: Write Only)

D7 D6 D5 D4 D3 D2 D. D0 P20 P27 I/O DEFINITION 0 DEFINES BIT AS OUTPUT 1 DEFINES BIT AS INPUT

R243 PRE1 Prescaler 1 Register

(F3_H Write Only)



R247 P3M Port 3 Mode Register

(F7H: Write Only)

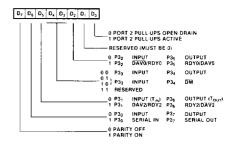


Figure 13. Control Registers

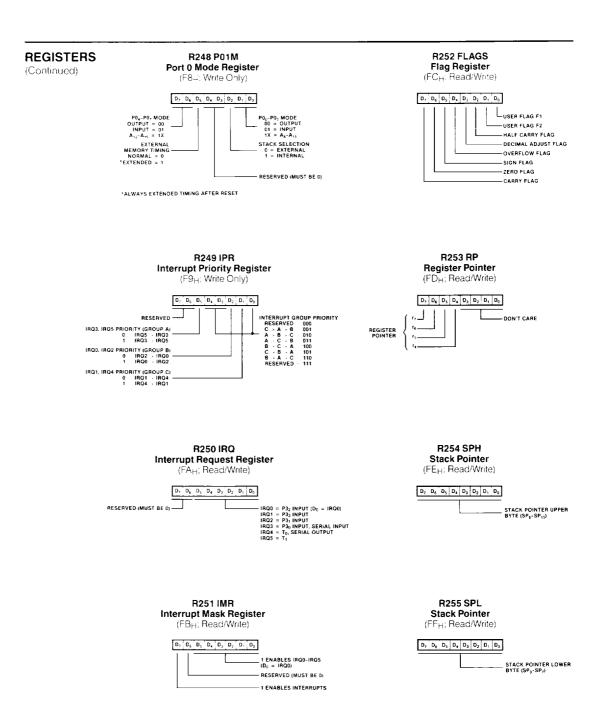


Figure 13. Control Registers (Continued)

OPCODE MAP

								Lower Nit	oble (Hex)							
	0	1	2	3	4	5	6	7	8	9	A	8	С	D	Ε	F
0	6.5 DEC 8+	6.5 DEC (R)	6.5 ADD 71.70	6.5 ADD H. Ig	10.5 ADD Bo.B.	10.5 ADD IR ₂ R ₁	10.5 ADD R-IM	10.5 ADD IR ₁ .IM	6.5 LD n. 8	6.5 LD r ₂ R ₁	12/10 5 DJNZ rRA	12/15 0 JR cc.RA	6.5 LD r _{1.} IM	12 10 0 j JP cc.DA	6.5 INC r1	1
1	6.5 RLC	6.5 RLC IR ₁	6.5 ADC	6.5 ADC	10.5 ADC Rg R	10.5 ADC IR ₂ .R ₁	10.5 ADC R _{1.IM}	10.5 ADC B ₁ IM				.				1
2	6.5 INC H ₁	6.5 INC IR ₁	6.5 SUB	65 SUB	10.5 SUB Rp.R ₁	10.5 SUB IR ₂ R ₁	:05 SUB R ₁ IM	10,5 SUB BollM								
3	8 0 JP	6.1 SRP IM	6.5 SBC	6.5 SBC	10.5 SBC	10.5 SBC	10.5 SBC	10,5 SBC	-							
4	1RR ₁ 8.5 DA	8,5 DA	6.5 OR	65 OA	10.5 OR	IR ₂ ,R ₁ 10.5 OR	10.5 OR	10.5 OR				1				
5	1 10 5 POP	10.5 POP	6.5 AND	6.5 AND	R ₂ .R ₁ 10,5 AND	1R ₂ ,R ₁ 10.5 AND	10.5 AND	10.5 AND								
6	6 5 COM	IR ₁ 6.5 COM	6.5 TCM	71 ¹ 12 6.5 TCM	R ₂ .R ₁ 10.5 TCM	10.5 TCM	R ₁ M 10.5 TCM	10.5 TCM	. :							
7	R ₁ 10/12.1 PUSH	12/14 1 PUSH		f ₁ lr ₂ 6.5 TM	H ₂ ,R ₁ 10.5 TM	IR ₂ .R ₁ 10.5 TM	R ₁ M 10.5 TM	10.5 TM								<u>. </u>
8	10.5 DECW BR-	10.5 DECW	11.12 12.0 LDE r _{1.1} lm ₂	18 0 LDEI lr ₁ .lr ₂	R ₂ .R ₁	. IR ₂ R ₁	R, M	IB ₁ .IM								6 1 DI
9	6.5 RL R ₁	6.5 RL IR ₁	2 0 LDE r ₂ iri	18.0 LDEI			<u>.</u>	—								6 1 EI
A	10.5 INCW RR ₁	10.5 INCW	6.5 CP	6.5 CP r · .lr ₂	10.5 CP R ₂ .R ₁	10.5 CP ⊞, R₁	10.5 CP R- IM	10.5 CP IR ₁ .IM								14 RE
В	6.5 CLR R ₁	6,5 CLR IB-	6.5 XOR f ₁ .f ₂	6.5 XOR r+.lrp	10.5 XOR R ₂ .R ₁	10.5 XOR Rg R-	10.5 XOR RIM	10.5 XOR IR. IM								16.0 • IRE
С	6.5 RRC 유 ₁	6.5 RRC IR ₁	12 0 LDC rr.lr ₂	18.0 LDCI Ir ₁ .lrr ₂				10.5 LD r _{1.} x.Fi ₂								6.5 RCI
D	6.5 SRA R ₁	65 SRA IR ₁	12.0 LDC r ₂ lm	18.0 LDCI lr ₂ ,lrr ₁	20 0 CALL* IRR ₁		20.0 CALL DA	10.5 LD r ₂ x,R+								6.5 SCI
E	6.5 RR R-	6 5 RR IR ₁		6.5 LD	10.5 LD R ₂ R ₁	10.5 LD IP ₂ R+	10.5 LD G - IM	10.5 LD IR ₁ IM								6.5 CCI
F	8.5 SWAP P.	8.5 SWAP IR•		6.5 LD		10.5 LD R ₂ IR ₁		† · · · · · · · · · · · · · · · · · · ·								6 0 NO I
						1. "	3			· *	2	· •		3		1
		•				·		Bytes per	Instruction	n	-			-		
				OPC	WER CODE BLE											
		EX	ECUTION CYCLES		\ ' /	PIPELINI CYCLES						address				
		UPPE OPCOO NIBBL)E	► A C) 5 P	MNEMOI	NIC					= Dst addre = Src addre				
			FIRST OPERANI		*	SECOND OPERAN					Opcode.			ond Operani iot defined	3	

^{*2-}byte instruction; fetch cycle appears as a 3-byte instruction

ABSOLUTE MAXIMUM RATINGS

Voltages on all pins except RESET
with respect to GND $-0.3V$ to $+7.0V$
Operating Ambient
TemperatureSee Ordering Information
Storage Temperature65°C to +150°C

Stresses greater than those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; operation of the device at any condition above those indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

STANDARD TEST CONDITIONS

The DC characteristics listed below apply for the following standard test conditions, unless otherwise noted. All voltages are referenced to GND. Positive current flows into the referenced pin.

Standard conditions are as follows:

- $+4.75V \le V_{CC} \le +5.25V$
- GND = 0V
- $0 \,^{\circ}\text{C} \leq T_A \leq +70 \,^{\circ}\text{C}$ for S (Standard temperature)
- -40 °C \leq T_A \leq + 100 °C for E (Extended temperature)

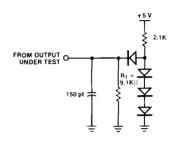


Figure 14. Test Load 1

DC CHARACTERISTICS

Symbol	Parameter	Min	Max	Unit	Condition
V _{CH}	Clock Input High Voltage	3.8	V _{CC}	٧	Driven by External Clock Generator
V_{CL}	Clock Input Low Voltage	-0.3	0.8	V	Driven by External Clock Generator
V_{IH}	Input High Voltage	2.0	V_{CC}	٧	
V _{IL}	Input Low Voltage	-0.3	8.0	V	
V _{RH}	Reset Input High Voltage	3.8	V_{CC}	٧	
V_{RL}	Reset Input Low Voltage	-0.3	8.0	V	
VOH	Output High Voltage	2.4		V	I _{OH} = -250 μA
VOL	Output Low Voltage		0.4	V	$I_{OL} = +2.0 \text{mA}$
I _{1L}	Input Leakage	-10	10	μΑ	$V_{IN} = 0V, 5.25V$
loL	Output Leakage	- 10	10	μ A	$V_{IN} = 0V, 5.25V$
I _{IR}	Reset Input Current		- 50	μΑ	$V_{CC} = +5.25V, V_{RL} = 0V$
loc	V _{CC} Supply Current		180	mA	All outputs and I/O pins floating

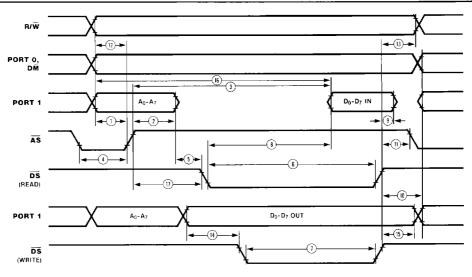


Figure 15. External I/O or Memory Read/Write Timing

AC CHARACTERISTICS

External I/O or Memory Read and Write Timing

			8 N	1Hz	12 (ИHz	
Number	Symbol	Parameter	Min	Max	Min	Max	Notes*†°
1	TdA(AS)	Address Valid to AS ↑ Delay	50	•	35		2,3
2	TdAS(A)	ĀS † to Address Float Delay	70		45		2,3
3	TdAS(DR)	ĀS ↑ to Read Data Required Valid		360		220	1,2,3
4	TwAS	AS Low Width	80		55		2,3
5	TdAz(DS)	Address Float to DS ↓	0		0		
6	TwDSR	DS (Read) Low Width	250		185		1,2,3
7	TwDSW	DS (Write) Low Width	160		110		1,2,3
8	TdDSR(DR)	DS ↓ to Read Data Required Valid		200		130	1,2,3
9	ThDR(DS)	Read Data to DS ↑ Hold Time	0		0		
10	TdDS(A)	DS ↑ to Address Active Delay	70		45		2,3
11	TdDS(AS)	DS ↑ to AS ↓ Delay	70		55		2,3
12	TdR/W(AS)	R/W Valid to AS↑ Delay	50		30		2,3
13	TdDS(R/W)	DS ↑ to R/W Not Valid	60		35		2,3
14	TdDW(DSW)	Write Data Valid to DS (Write) ↓ Delay	50		35		2,3
15	TdDS(DW)	DS ↑ to Write Data Not Valid Delay	60		35		2,3
16	TdA(DR)	Address Valid to Read Data Required Valid		410		255	1,2,3
17	TdAS(DS)	AS ↑ to DS ↓ Delay	80		55		2,3

NOTES:

- 1. When using extended memory timing add 2 TpC.
- 2. Timing numbers given are for minimum TpC.
- 3. See clock cycle time dependent characteristics table.
- * All units in nanoseconds (ns).
- † Test Load 1
- ° All timing references use 2.0V for a logic "1" and 0.8V for a logic "0".

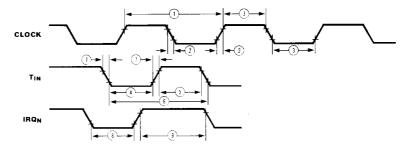


Figure 16. Additional Timing

AC CHARACTERISTICS

Additional Timing Table

			8 N	1Hz	12 1	ИHz	
Number	Symbol	Parameter	Min	Max	Min	Max	Notes*
1	TpC	Input Clock Period	125	1000	83	1000	1
2	TrC,TfC	Clock Input Rise and Fall Times		25		15	1
3	TwC	Input Clock Width	37		70		1
4	TwTinL	Timer Input Low Width	100		70		2
5	TwTinH	Timer Input High Width	3TpC		3TpC		2
6	TpTin	Timer Input Period	8TpC		8TpC		2
7	TrTin,TfTin	Timer Input Rise and Fall Times		100		100	2
8A	TwlL	Interrupt Request Input Low Time	100		70		2,4
8B	TwIL	Interrupt Request Input Low Time	3TpC		3TpC		2,5
9	TwiH	Interrupt Request Input High Time	3TpC		3TpC		2,3

NOTES:

- 1. Clock timing references use 3.8V for a logic "1" and 0.8V for a logic "0". 2. Timing references use 2.0V for a logic "1" and 0.8V for a logic "0".
- 3. Interrupt request via Port 3.
- 4. Interrupt request via Port 3 (P3₁-P3₃)
- 5. Interrupt request via Port 3 (P3₀)
- * Units in nanoseconds (ns).

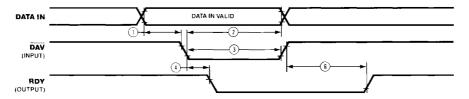


Figure 17a. Input Handshake Timing

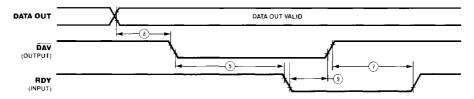


Figure 17b. Output Handshake Timing

AC CHARACTERISTICS

Handshake Timing

Number	Symbol	Parameter	Min 8 N	iHz Max	12 M	/Hz Max	Notes†
1	TsDI(DAV)	Data In Setup Time	0		0	IVIUA	
2	ThDI(DAV)	Data In Hold Time	230		160		
3	TwDAV	Data Available Width	175		120		
4	TdDAVIf(RDY)	DAV ↓ Input to RDY ↓ Delay		175		120	1,2
5	TdDAVOf(RDY)	DAV ↓ Output to RDY ↓ Delay	0		0		1,3
6	TdDAVIr(RDY)	DAV ↑ Input to RDY ↑ Delay		175		120	1,2
7	TdDAVOr(RDY)	DAV † Output to RDY † Delay	0		0		1,3
8	TdDO(DAV)	Data Out to DAV ↓ Delay	50		30		1
9	TdRDY(DAV)	Rdy ↓ Input to DAV ↑ Delay	0	200	0	140	1

NOTES:

- 1. Test load 1
- 2. Input handshake
- 3. Output handshake
- † All timing references use 2.0V for a logic "1" and 0.8V for a logic "0".
- * Units in nanoseconds (ns).

CLOCK CYCLE TIME-DEPENDENT CHARACTERISTICS

Number	Symbol	8 MHz Equation	12 MHz Equation
1	TdA(AS)	TpC-75	TpC-50
2	TdAS(A)	TpC-55	TpC-40
3	TdAS(DR)	4TpC-140*	4TpC-110*
4	TwAS	TpC-45	TpC-30
6	TwDSR	3TpC-125*	3TpC-65*
7	TwDSW	2TpC-90*	2TpC-55*
8	TdDSR(DR)	3TpC-175*	3TpC-120*
10	Td(DS)A	TpC-55	TpC-40
11	TdDS(AS)	TpC-55	TpC-30
12	TdR/W(AS)	TpC-75	TpC-55
13	TdDS(R/W)	TpC-65	TpC-50
14	TdDW(DSW)	TpC-75	TpC-50
15	TdDS(DW)	TpC-55	TpC-40
16	TdA(DR)	5TpC-215*	5TpC-160 *
17	TdAS(DS)	TpC-45	TpC-30

^{*}Add 2TpC when using extended memory timing